

T6A39

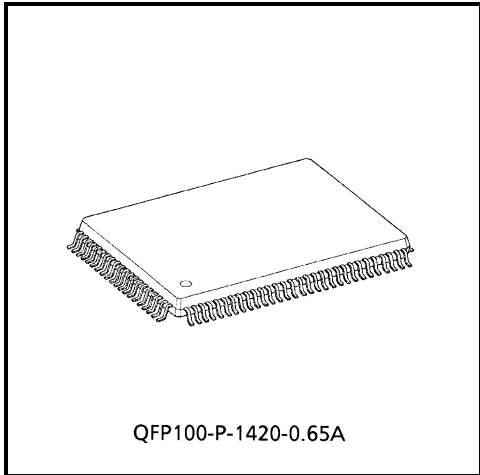
COLUMN DRIVER FOR A DOT MATRIX LCD

The T6A39 is an 80-channel-output column driver for an STN dot matrix LCD.

The T6A39 features a 28-V LCD drive voltage and a 4-MHz maximum operating frequency. The T6A39 is able to drive LCD panels with a duty ratio of up to 1/240. It is recommended for use with the T6A40.

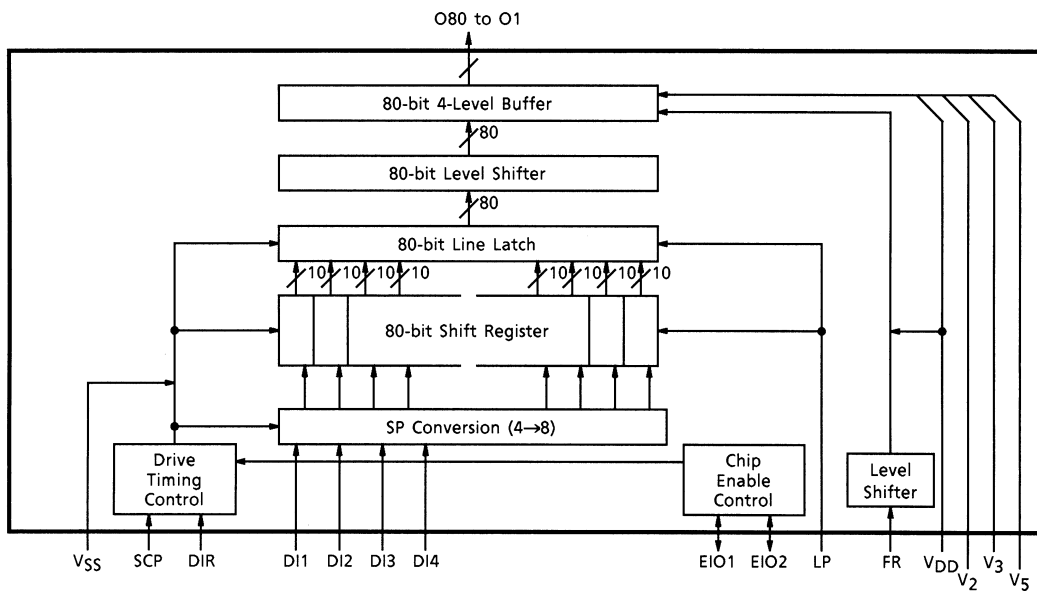
Features

- Display duty application : to 1/240
- LCD drive signal : 80
- Data transfer : 1, 2, 4-bit bidirectional
- Operating frequency : 4 MHz
- LCD drive voltage : 8 to 28 V (max 30 V)
- Power supply voltage : 4.5 to 5.5 V
- Operating temperature : -20 to 75°C
- LCD drive output resistance : 1.5 kΩ (max) (12.8 V, 1/9 bias)
- Low power consumption : Cascade connection and auto enable transfer functions are available.

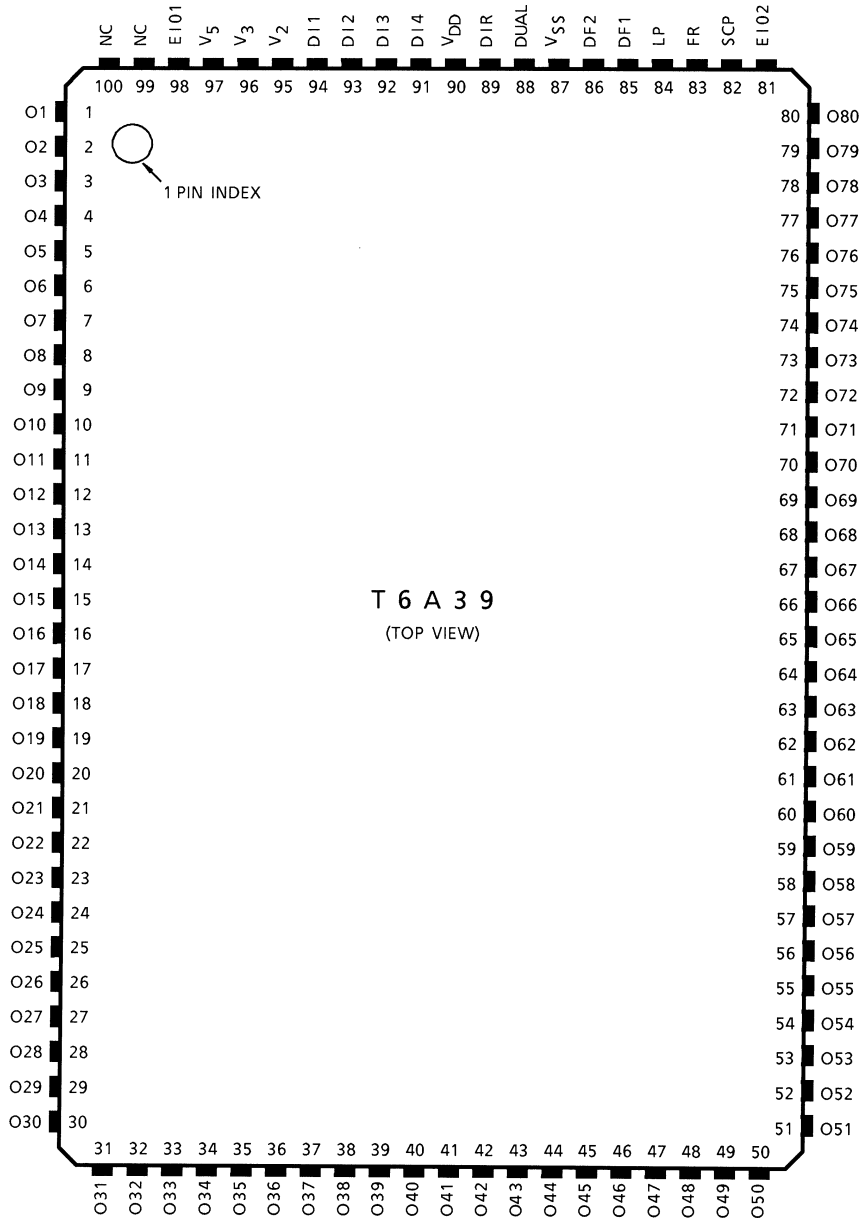


Weight: 1.60 g (typ.)

Block Diagram



Pin Assignment



Pin Functions

Pin Name	I / O	Functions	Level																				
O1 to O80	Output	Output for LCD drive signal	V_{DD} to V_5																				
DI1 to DI4	Input	Input for shift data	V_{DD} to V_{SS}																				
SCP	Input	(Shift Clock Pulse) Input for shift clock pulse																					
FR	Input	(Frame) Input for frame signal																					
LP	Input	(Latch Pulse) Input for shift clock pulse																					
DUAL	Input	(Dual Mode) Terminal for dual input mode or single input mode select																					
DIR	Input	(Direction) Input for data flow direction select																					
DF1, DF2	Input	(Data Format) Input for selection data format (1-bit, 2-bit, 4-bit)																					
EIO1, EIO2	I / O	(Input / output for ENABLE signal) At cascade connection of the T6A39, connect output pin to enable pin (input) of next LSI externally.																					
			<table border="1"> <thead> <tr> <th>DUAL</th> <th>DIR</th> <th>EION1</th> <th>EION2</th> </tr> </thead> <tbody> <tr> <td>L</td> <td>L</td> <td>OUT</td> <td>IN</td> </tr> <tr> <td>L</td> <td>H</td> <td>IN</td> <td>OUT</td> </tr> <tr> <td>H</td> <td>L</td> <td>OUT</td> <td>IN</td> </tr> <tr> <td>H</td> <td>H</td> <td>OUT</td> <td>IN</td> </tr> </tbody> </table>	DUAL	DIR	EION1	EION2	L	L	OUT	IN	L	H	IN	OUT	H	L	OUT	IN	H	H	OUT	IN
DUAL	DIR	EION1	EION2																				
L	L	OUT	IN																				
L	H	IN	OUT																				
H	L	OUT	IN																				
H	H	OUT	IN																				
V_{DD}	—	Power supply for internal logic (+5 V)	—																				
V_{SS}	—	Power supply for internal logic (0 V)																					
V_2	—	Power supply for LCD drive circuit																					
V_3	—	Power supply for LCD drive circuit																					
V_5	—	Power supply for LCD drive circuit																					

Relation Between FR, Data Input and Output Level

F R	Data Input (DI1 to DI4)	Output Level
L	L	V_2
L	H	V_{DD}
H	L	V_3
H	H	V_5

Data Input Format

DF1	DF2	DUAL	DIR	bits	DATA INPUT				DATA FORMAT										
					D11	D12	D13	D14	D11	D12	D13	D14	D11	D12	D13	D14			
L	L	L	L	1-bit	*	*	*	IN	—	—	—	—	—	—	—	—	—	O80,O79...O2,O1	—
L	L	L	H		IN	*	*	*	*	O1,O2...O79,O80	—	—	—	—	—	—	—	—	—
L	L	H	L	1-bit	*	*	*	IN	—	—	—	—	—	—	—	—	—	O80,O79...O42,O41	—
L	L	H	H		IN	*	*	*	*	O1,O2...O39,O40	—	—	—	—	—	—	—	—	O80,O79...O42,O41
H	L	L	L	2-bit	*	*	IN	IN	—	—	—	O79,O77...O3,O1	—	—	—	—	—	O80,O78...O4,O2	—
H	L	L	H		IN	IN	*	*	*	O1,O3...O77,O79	O2,O4...O78,O80	—	—	—	—	—	—	—	—
H	L	H	L	2-bit	*	*	IN	IN	—	—	—	—	—	—	—	—	—	O79,O77...O43,O41	—
H	L	H	H		IN	IN	IN	IN	IN	O1,O3...O37,O39	O2,O4...O38,O40	O79,O77...O43,O41	—	—	—	—	—	O80,O78...O44,O42	
*	H	L	L	4-bit	IN	IN	IN	IN	O77,O73...O5,O1	O78,O74...O6,O2	O79,O75...O7,O3	—	—	—	—	—	—	O80,O76...O8,O4	—
*	H	L	H		IN	IN	IN	IN	IN	O1,O5...O73,O77	O2,O6...O74,O78	O3,O7...O75,O79	—	—	—	—	—	O4,O8...O76,O80	—
*	H	H	L	4-bit	IN	IN	IN	IN	O77,O73...O45,O41	O78,O74...O46,O42	O79,O75...O47,O43	—	—	—	—	—	—	O80,O76...O48,O44	—
*	H	H	H		IN	IN	IN	IN	IN	—	—	—	—	—	—	—	—	—	—

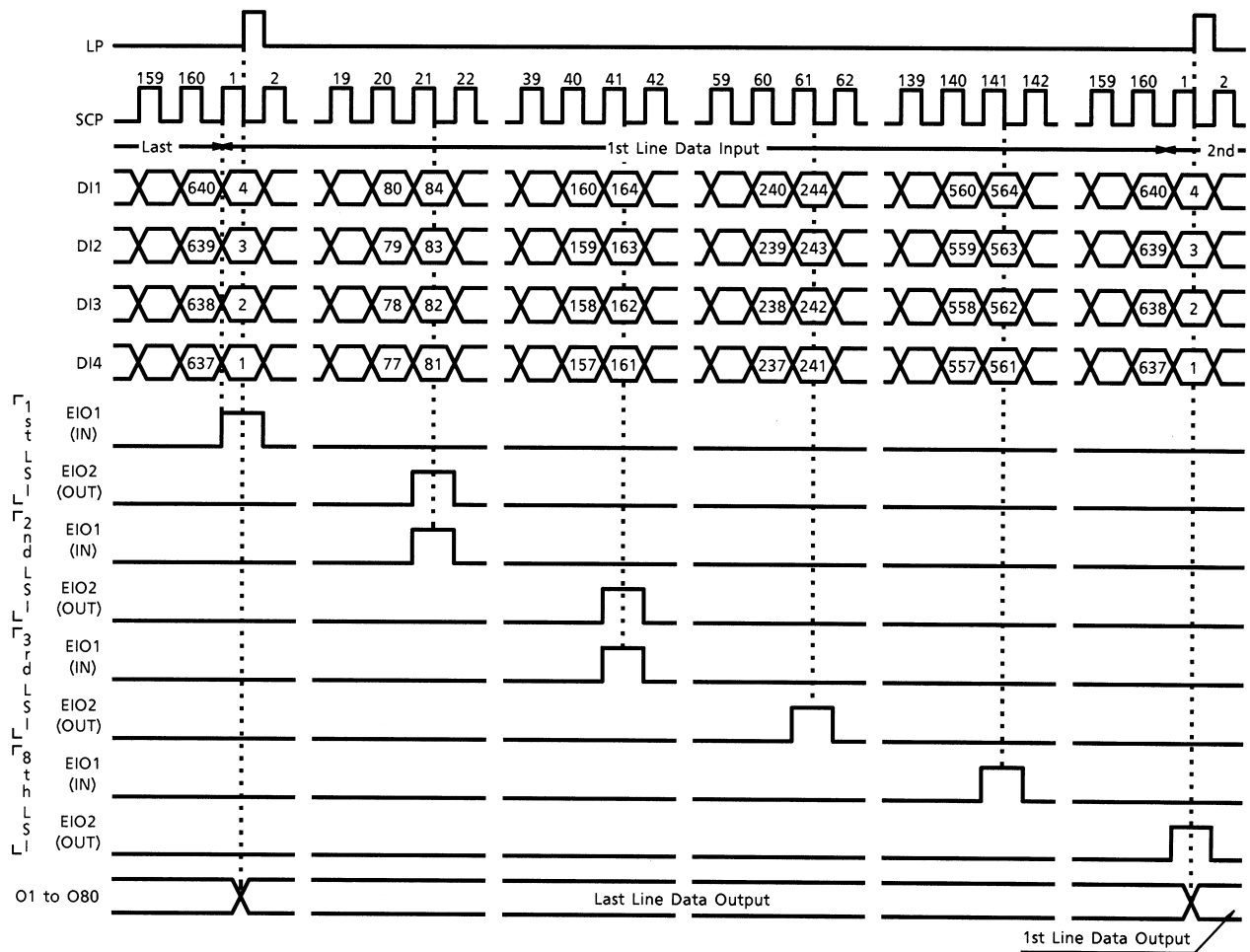
* Don't Care

☐→LAST DATA

☐→FIRST DATA

Timing Diagram

DIR = L



Absolute Maximum Ratings (Ensure that the Following Conditions are Maintained,) $V_{CC} \geq V_0 \geq V_2 \geq V_3 \geq V_5 \geq V_{SS}, V_{SS} = 0V$

Item	Symbol	Pin Name	Rating	Unit
Supply Voltage 1	V_{DD}	V_{DD}	-0.3 to 7.0	V
Supply Voltage 2	V_2	V_2	$V_{DD} - 30$ to $V_{DD} + 0.3$	V
Supply Voltage 3	V_3	V_3	$V_{DD} - 30$ to $V_{DD} + 0.3$	V
Supply Voltage 4	V_5	V_5	$V_{DD} - 30$ to $V_{DD} + 0.3$	V
Input Voltage	V_{IN}	(Note 1)	-0.3 to $V_{DD} + 0.3$	V
Operating Temperature	T_{opr}	—	-20 to 75	°C
Storage Temperature	T_{stg}	—	-55 to 125	°C

Note 1: SCP, FR, LP, DIR, DF1, DF2, DUAL, DI1 to DI4

Electrical Characteristics

Dc Characteristics

Test Conditions (Unless Otherwise Noted, $V_{SS} = 0\text{ V}$, $V_{DD} = 4.5\text{ to }5.5\text{ V}$, $V_5 = (V_{DD} - 23)\text{ V} \pm 10\%$, $T_a = -20\text{ to }75^\circ\text{C}$)

Item	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit	Pin Name	
Supply Voltage 1	—	—	—	4.5	5.0	5.5	V	V_{DD}	
Supply Voltage 2	V_5	—	—	$V_{DD} - 28$	$V_{DD} - 23$	$V_{DD} - 8.0$	V	V_5	
Input Voltage	H Level	V_{IH}	—	$T_{opr} = -10\text{ to }75^\circ\text{C}$ (Note2)	$V_{DD} - 0.8$ (Note 3)	—	V_{DD}	V	SCP, FR, LP, DIR, EIO1, EIO2, DI1 to DI4, DF1, DF2, DUAL
	L Level	V_{IL}		$T_{opr} = -10\text{ to }75^\circ\text{C}$ (Note2)	0	—	0.8 (Note 4)		
Output Voltage	H Level	V_{OH}	—	—	$V_{DD} - 0.3$	—	V_{DD}	V	EIO1, EIO2
	L Level	V_{OL}		—	0	—	0.3		
Output Resistance (1)	H Level	R_{OH}	—	$V_{OUT} = V_{DD} - 0.5\text{ V}$	—	—	1.0	k Ω	EIO1, EIO2
	L Level	R_{OL}		$V_{OUT} = V_{SS} + 0.5\text{ V}$	—	—	1.0		
Output Resistance (2)	H Level	R_{OH}	—	$V_{OUT} = V_{DD} - 0.5\text{ V}$ (Note 5)	—	—	1.5	k Ω	O1 to O80
	M Level	R_{OM}		$V_{OUT} = V_2 \pm 0.5\text{ V}$ (Note 5)	—	—	1.5		
		R_{OM}		$V_{OUT} = V_3 \pm 0.5\text{ V}$ (Note 5)	—	—	1.5		
L Level	R_{OL}	$V_{OUT} = V_5 + 0.5\text{ V}$ (Note 5)	—	—	1.5				
Current Consumption (1) (Note 5)	I_{SS}	—	$V_{DD} = 5.5\text{ V}$ $V_5 = -22.5\text{ V}$ $f_{FR} = 35\text{ Hz}$ $f_{SCP} = 2.5\text{ MHz}$ O1 to O80 : No Load (Note 7)	Input Data: every bit inverted	—	1050	1400	μA	VSS
				Input Data: low	—	770	1000		
Current Consumption (2) (Note 6)	I_{SS}	—	As mentioned above (Note 7)	Input Data: every bit inverted	—	260	350	μA	VSS

Note 2: $R_L = 3\text{ k}\Omega$, $C_L = 500\text{ pF}$

Note 3: $V_{DD} - 0.7$ ($T_{opr} = -20\text{ to }-10^\circ\text{C}$)

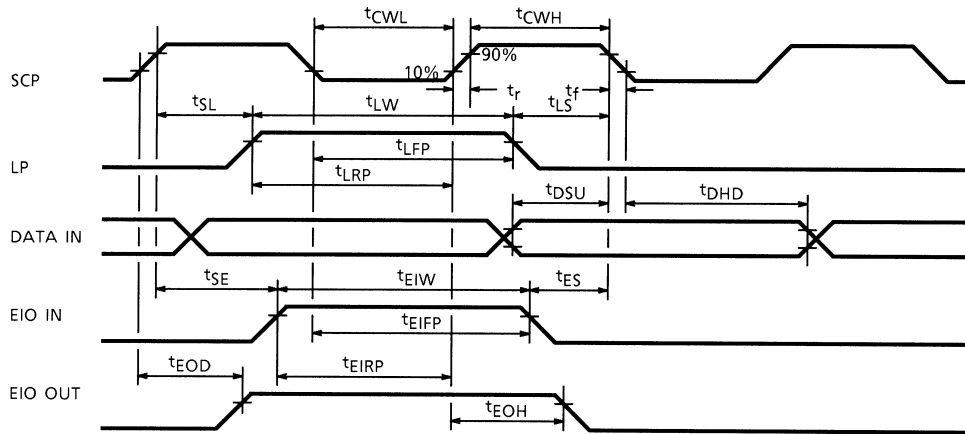
Note 4: 0.7 ($T_{opr} = -20\text{ to }-10^\circ\text{C}$)

Note 5: Internal data receiver operating

Note 6: Internal data receiver sleeping

Note 7: $V_{DD} = 5.0\text{ V}$, $V_5 = -7.8\text{ V}$, $V_2 = V_{DD} - 2/9 (V_{DD} - V_5)$, $V_3 = V_{DD} - 7/9 (V_{DD} - V_5)$

AC Characteristics



Test Conditions

($V_{SS} = 0\text{ V}$, $V_{DD} = 4.5\text{ to }5.5\text{ V}$, $V_0 = V_{DD}$, $V_5 = (V_{DD} - 23)\text{ V} \pm 10\%$, $T_a = -20\text{ to }75^\circ\text{C}$)

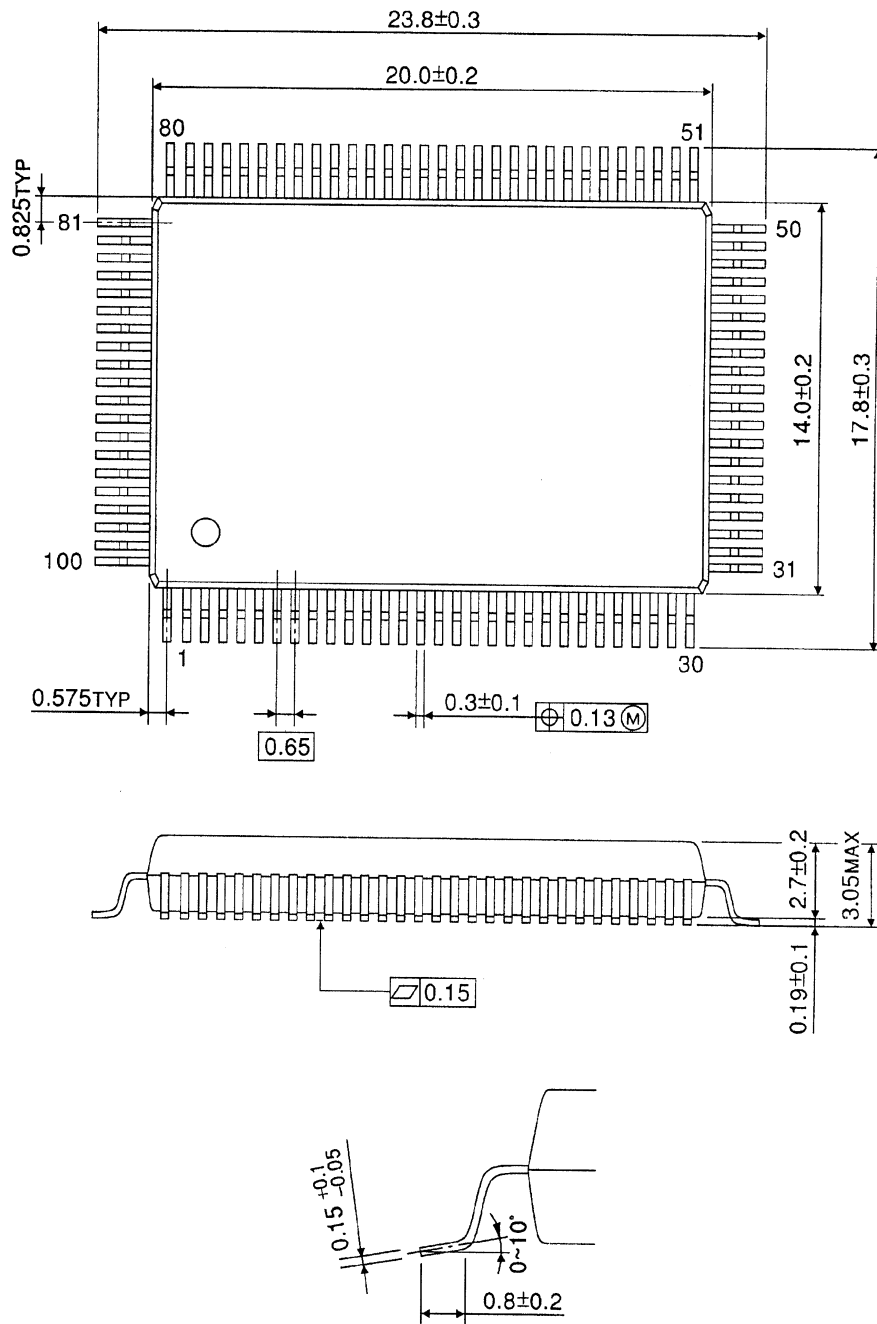
Item	Symbol	Test Condition	Min	Max	Unit
Operating Frequency	t_{SCP}	—	—	4.0	MHz
SCP Pulse Width	t_{CWH}	—	95	—	ns
SCP Pulse Width	t_{CWL}	—	95	—	
Data Set-up Time	t_{DSU}	—	20	—	
Data Hold Time	t_{DHD}	—	40	—	
SCP Rise / Fall Time	t_r, t_f	—	—	30	
LP Set-up Time	t_{LRP}	—	20	—	
LP Hold Time	t_{LFP}	—	40	—	
LP Pulse Width	t_{LW}	—	40	—	
SCP-Rise-to-LP-Rise Time	t_{SL}	—	10	—	
LP-Fall-to-SCP-Fall Time	t_{LS}	—	10	—	
EIO IN Set-up Time	t_{EIRP}	—	20	—	
EIO IN Hold Time	t_{EIFP}	—	40	—	
EIO IN Pulse Width	t_{EIW}	—	40	—	
SCP-Rise-to-EIO-Rise Time	t_{SE}	(Note 8)	10	—	
EIO-Fall-to-SCP-Fall Time	t_{ES}	(Note 8)	10	—	
EIO OUT Data Delay Time	t_{EOD}	—	—	100	
EIO OUT Hold Time	t_{EOH}	—	—	95	

Note 8: $C_L = 10\text{ pF}$

Package Dimensions

QFP100-P-1420-0.65A

Unit: mm



Weight : 1.60g (typ.)

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